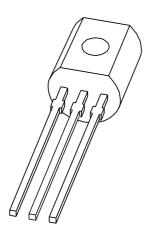
DISCRETE SEMICONDUCTORS

DATA SHEET



2N5401PNP high-voltage transistor

Product specification Supersedes data of 1999 Apr 08

2004 Oct 28





PNP high-voltage transistor

2N5401

FEATURES

- Low current (max. 300 mA)
- High voltage (max. 150 V).

APPLICATIONS

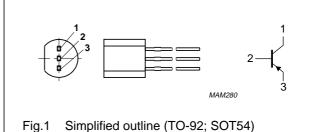
- General purpose switching and amplification
- Telephony applications.

DESCRIPTION

PNP high-voltage transistor in a TO-92; SOT54 plastic package. NPN complement: 2N5551.

PINNING

PIN	DESCRIPTION
1	collector
2	base
3	emitter



and symbol.

ORDERING INFORMATION

TYPE NUMBER		PACKAGE					
ITPE NOWIBER	NAME	DESCRIPTION	VERSION				
2N5401	SC-43A	plastic single-ended leaded (through hole) package; 3 leads	SOT54				

LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 60134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V _{CBO}	collector-base voltage	open emitter	_	-160	V
V _{CEO}	collector-emitter voltage	open base	_	-150	V
V _{EBO}	emitter-base voltage	open collector	_	- 5	V
I _C	collector current (DC)		_	-300	mA
I _{CM}	peak collector current		_	-600	mA
I _{BM}	peak base current		_	-100	mA
P _{tot}	total power dissipation	T _{amb} ≤ 25 °C	_	630	mW
T _{stg}	storage temperature		-65	+150	°C
Tj	junction temperature		_	150	°C
T _{amb}	ambient temperature		-65	+150	°C

THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
R _{th(j-a)}	thermal resistance from junction to ambient	note 1	200	K/W

Note

1. Transistor mounted on an FR4 printed-circuit board.

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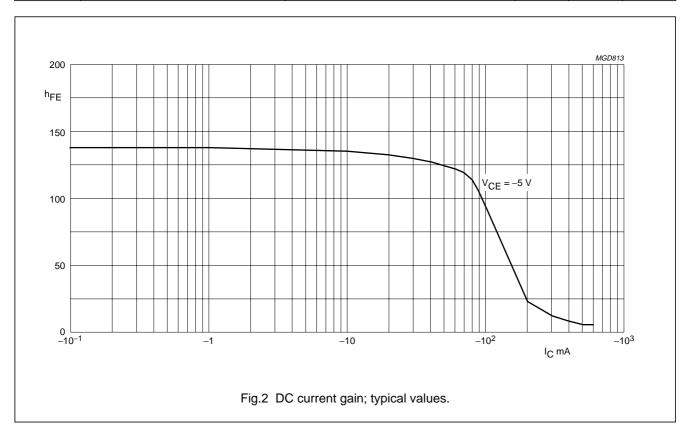
PNP high-voltage transistor

2N5401

CHARACTERISTICS

 T_{amb} = 25 °C unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
I _{CBO}	collector-base cut-off current	$V_{CB} = -120 \text{ V}; I_E = 0 \text{ A}$	_	-50	nA
		$V_{CB} = -120 \text{ V}; I_E = 0 \text{ A}; T_j = 100 ^{\circ}\text{C}$	_	-50	μΑ
I _{EBO}	emitter-base cut-off current	$V_{EB} = -4 \text{ V}; I_C = 0 \text{ A}$	_	-50	nA
h _{FE}	DC current gain	V _{CE} = −5 V; see Fig.2			
		$I_C = -1 \text{ mA}$	50	_	
		$I_C = -10 \text{ mA}$	60	240	
		$I_C = -50 \text{ mA}$	50	_	
V _{CEsat}	collector-emitter saturation voltage	$I_C = -10 \text{ mA}; I_B = -1 \text{ mA}$	_	-200	mV
		$I_C = -50 \text{ mA}; I_B = -5 \text{ mA}$	_	-500	mV
C _c	collector capacitance	$V_{CB} = -10 \text{ V}; I_E = i_e = 0 \text{ A}; f = 1 \text{ MHz}$	_	6	pF
f _T	transition frequency	$V_{CE} = -10 \text{ V}; I_{C} = -10 \text{ mA}; f = 100 \text{ MHz}$	100	300	MHz
F	noise figure	V_{CE} = -5 V; I_{C} = -200 μA; R_{S} = 2 kΩ; f = 10 Hz to 15.7 kHz	_	8	pF



Philips Semiconductors Product specification

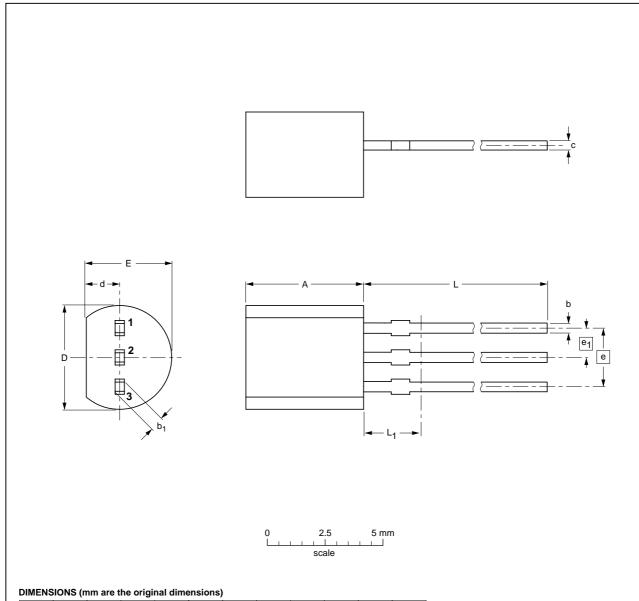
PNP high-voltage transistor

2N5401

PACKAGE OUTLINE

Plastic single-ended leaded (through hole) package; 3 leads

SOT54



UNIT	A	b	b ₁	С	D	d	E	е	e ₁	L	L ₁ ⁽¹⁾ max.	
mm	5.2 5.0	0.48 0.40	0.66 0.55	0.45 0.38	4.8 4.4	1.7 1.4	4.2 3.6	2.54	1.27	14.5 12.7	2.5	

Note

1. Terminal dimensions within this zone are uncontrolled to allow for flow of plastic and terminal irregularities.

OUTLINE		REFER	EUROPEAN	ISSUE DATE		
VERSION	IEC	JEDEC	JEITA		PROJECTION	1330E DATE
SOT54		TO-92	SC-43A			97-02-28 04-06-28

Philips Semiconductors Product specification

PNP high-voltage transistor

2N5401

DATA SHEET STATUS

LEVEL	DATA SHEET STATUS ⁽¹⁾	PRODUCT STATUS(2)(3)	DEFINITION
I	Objective data	Development	This data sheet contains data from the objective specification for product development. Philips Semiconductors reserves the right to change the specification in any manner without notice.
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Limiting values definition — Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 60134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

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